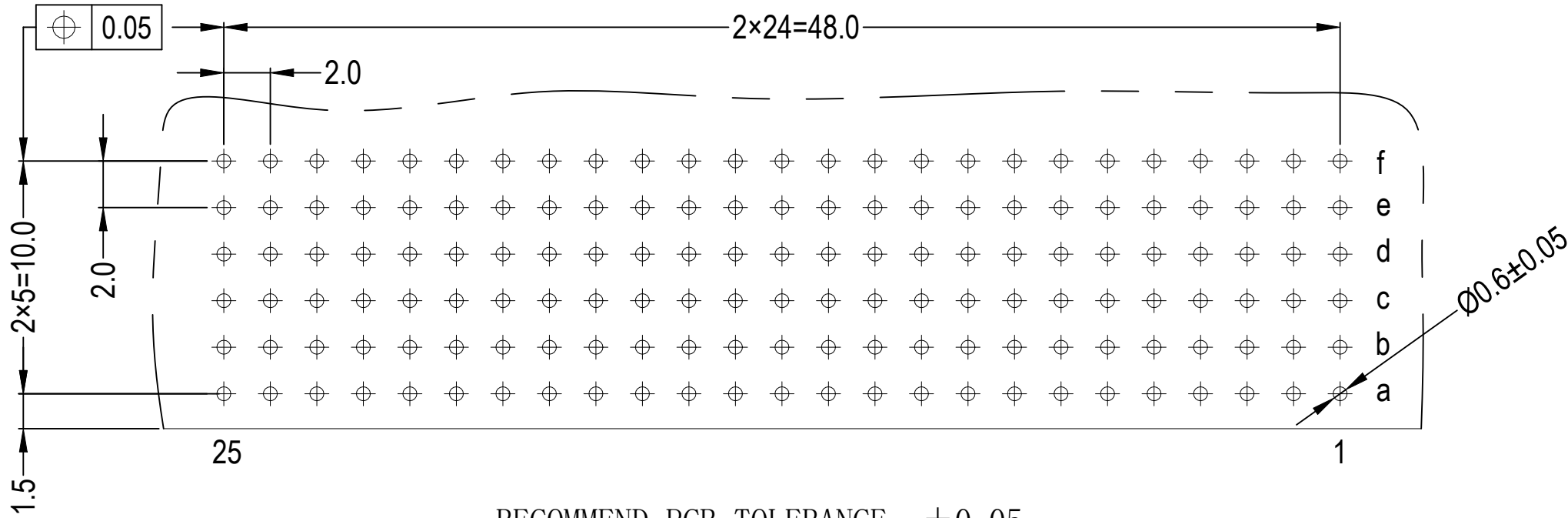
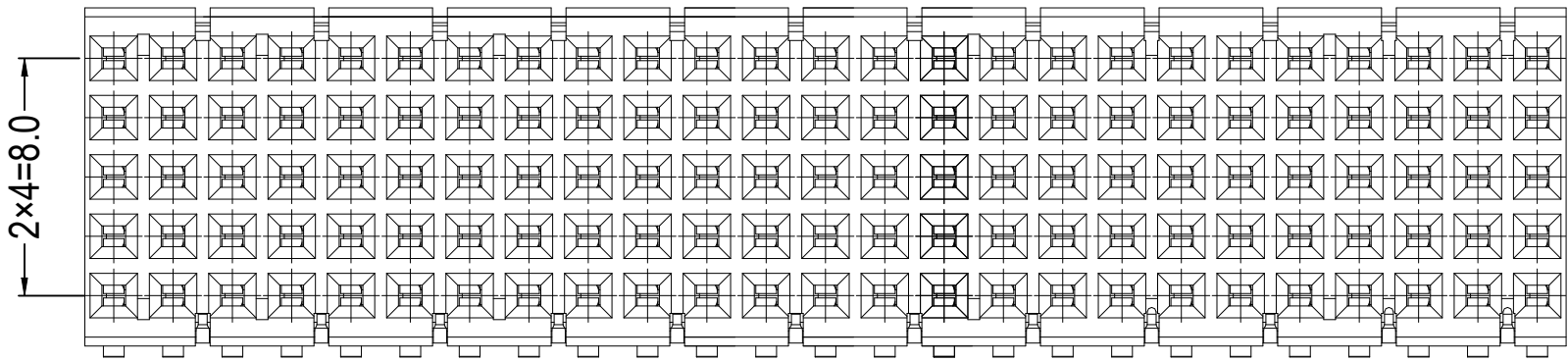
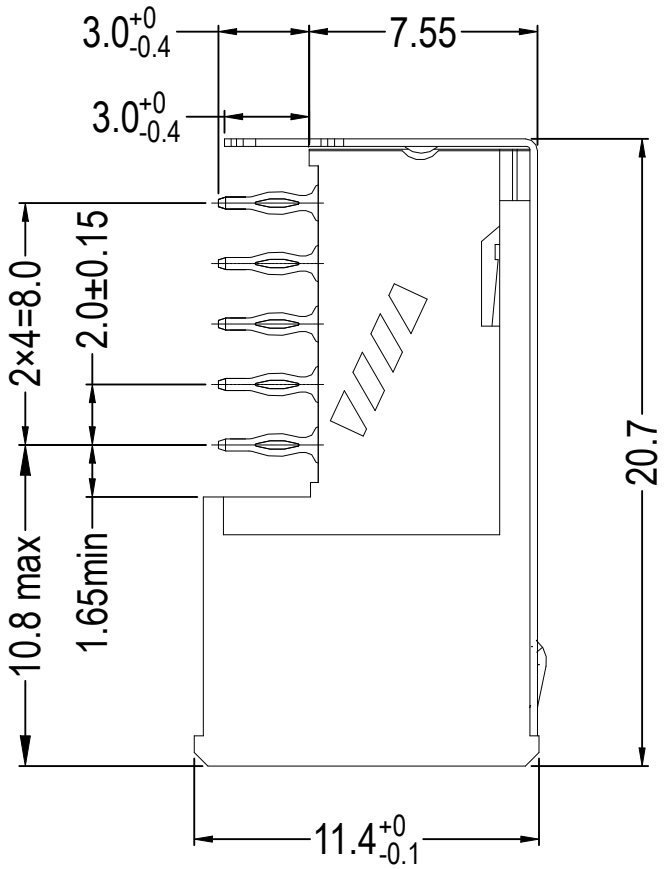
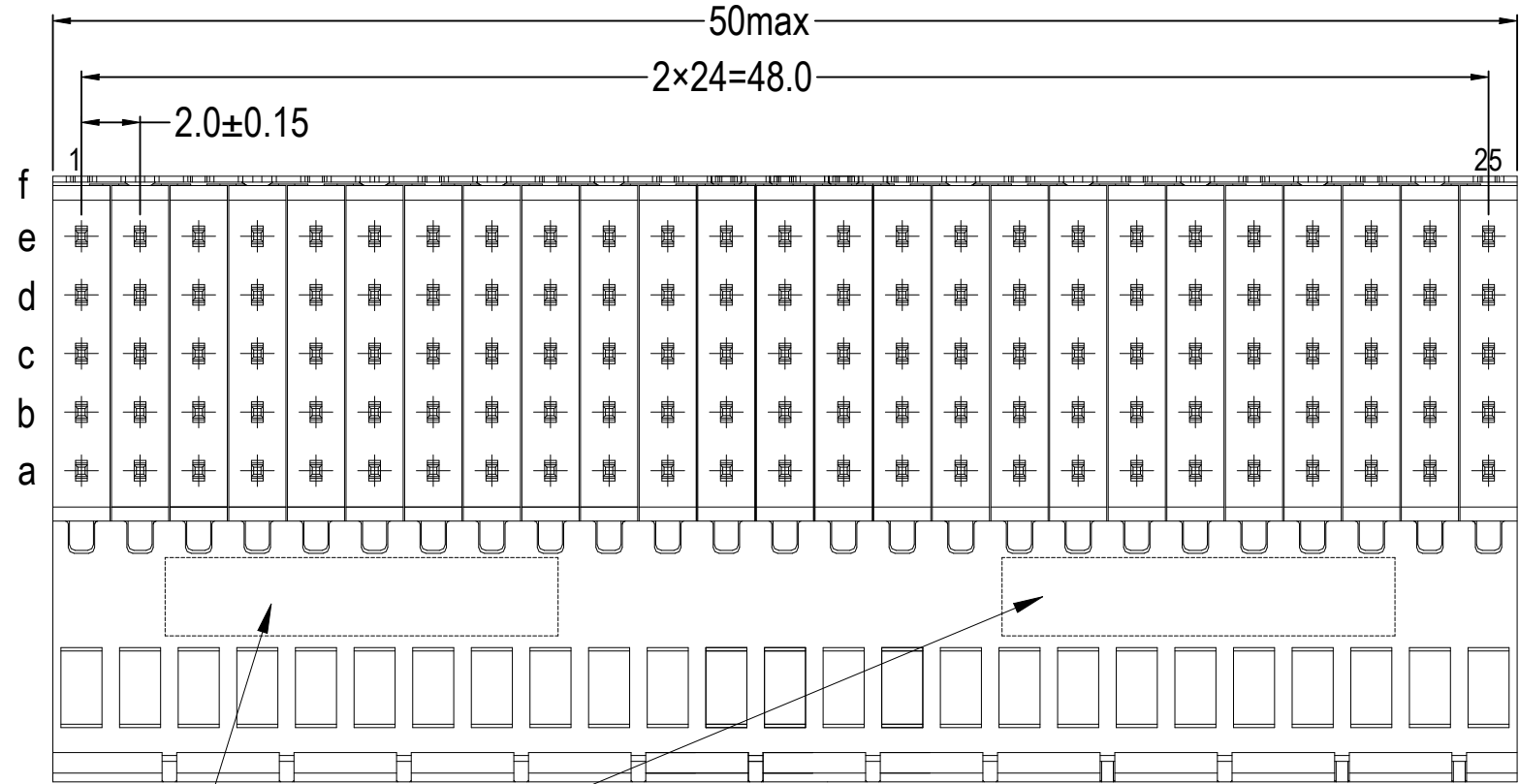


REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
	A	INITIAL DRAWING	19OCT2021	TL	HL

- NOTES:
- 1 MATERIAL CONTACTS; COPPER ALLOY
MATERIAL HOUSING; GLASSFILLED POLYESTER
 - 2 GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT):
1,27µm NICKEL MIN. AND EON PIN: 0,5µm TIN MIN.
FOR PLATING OF MATING SURFACES SEE APPLICABLE SPECIFICATION
REFERENCE FOR EACH DASH NUMBER.
 - 3 CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101
PERFORMANCE LEVEL 2.
 - 4 ASSEMBLY PRINTED WITH P/N AND DATECODE



RECOMMEND PCB TOLERANCE : ±0.05

		23		1		2392577-1	
		FINISH		MATERIAL		PART NUMBER	
THIS DRAWING IS A CONTROLLED DOCUMENT.				DWN TONY LI 28MAY2021		TE TE Connectivity Ltd.	
DIMENSIONS: mm							